WCN Opto Group Co., Limited

WCN1-1052SD-C31

SPECIFICATION

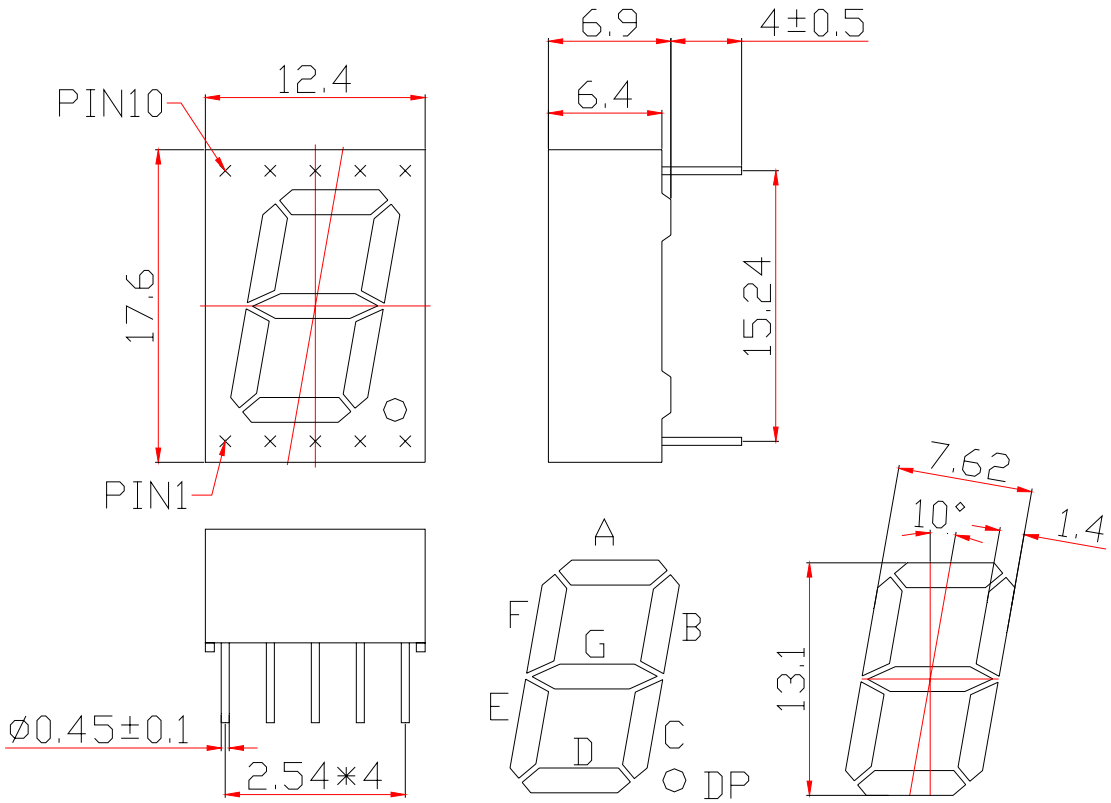
WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Fei	Athena		
REVISION RECORD			

RoHS

恒盛源光电科技(深圳)有限公司 开发部 WCN

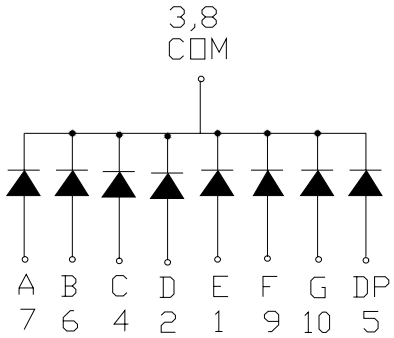
REVISION: A0

■ Outer Dimension:



Notes: Unless otherwise stated, the tolerance is ±0.25mm.

■ Circuit Diagram



■ Pin Connection:

PIN NO.	CONNECTION	PIN NO.	CONNECTION
1	Anode E	6	Anode B
2	Anode D	7	Anode A
3	Common Cathode	8	Common Cathode
4	Anode C	9	Anode F
5	Anode DP	10	Anode G

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Features:

- **High Reliability**
- **Color: Bright Red**
- **Low Power Requirement**
- **Easy Assembly**

Description:

- **Single Digit LED Display**
- **Digit Height: 13.1mm(0.52)**
- **Gray Face and Milky Diffused Segment**

Absolute Maximum Rating (Ta=25) / Per Dice:

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation	P_d		Red	65	mW
Forward Current	I_F		Red	25	mA
Derating Of If Per	I_F	Ta 25	Red	0.30	mA/
Peak Forward Current	I_{FP}	1/10 Duty 10KHz	Red	100	mA
Reverse Voltage	V_R		Red	5	V
Operating Temperature Range	Topr			-35 +85	
Storage Temperature Range	Tstg			-35 +85	

Electrical/Optical Characteristics Rating(Ta=25)

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V_F	I_F=20mA	Per Dice		2.00	2.60	V
Reverse Current	I_R	V_R=5V	Per Dice			100	A
Luminous Intensity	I_V	I_F=10mA	Per Dice	8501	14000		cd
Wave Length	P	I_F=20mA	Per Dice		660		nm
	D				640		
Spectral Line Half Width		I_F=20mA	Per Dice		20		nm
Luminous Intensity Matching Ratio	I_{v-m}	I_F=10mA				2:1	

Luminous Intensity Sorting: (Luminous intensity tolerance: +/-10%)

Rank	Symbol	Condition	Min	Max	Unit
P	P	I_F =10mA	8501	10500	cd
Q	Q	I_F =10mA	10501	12800	cd
R	R	I_F =10mA	12801	15250	cd
S	S	I_F =10mA	15251	18000	cd
T	T	I_F =10mA	18001	21500	cd

Hue Grade: I_F =10mA (Hue:+/-1nm)

Rank	Symbol	Hue Range	Units
69	69	636.1-639.0	nm
70	70	639.1-642.0	nm

Soldering Conditions: Soldering Temp. +260 Soldering Time. 3sec.

(at 2mm Distance from The Case of Reflector Ed

Typical Electro-Optical Characteristics Curve:

Fig1. Forward Current vs. Forward Voltage:

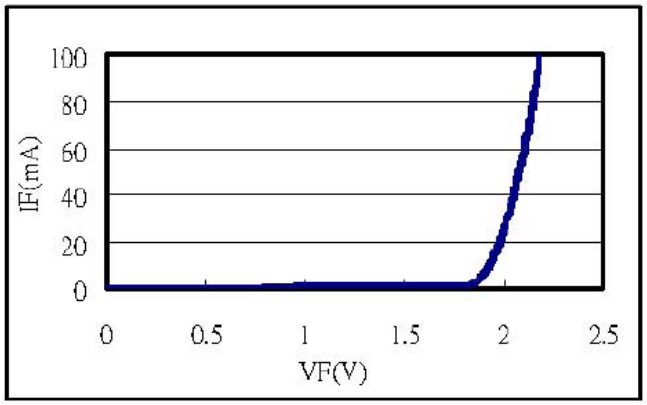


Fig2. Forward Current vs. Relative Intensity:

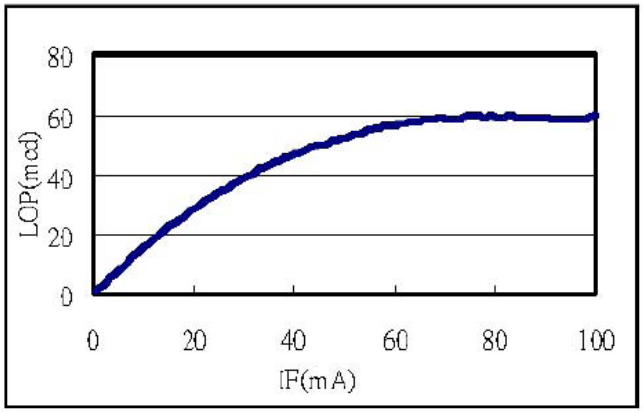


Fig3. Forward Current vs. Relative Wavelength:

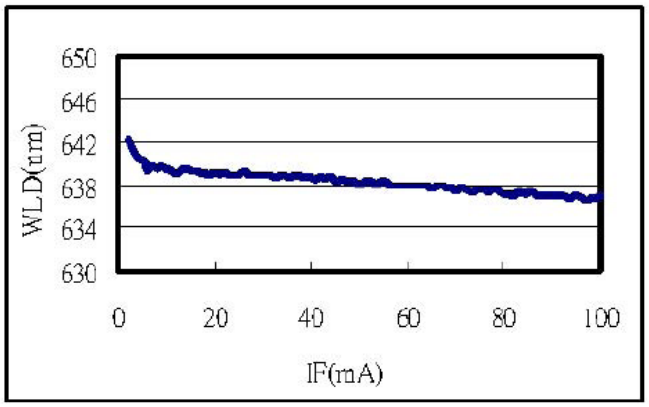


Fig4. Temperature vs. Relative Intensity:

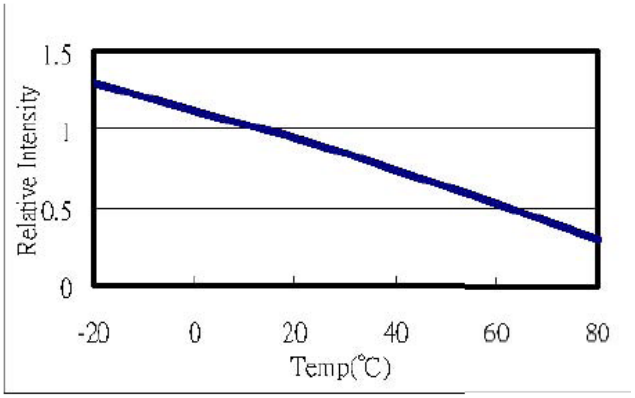


Fig5. Temperature vs. Relative Wavelength:

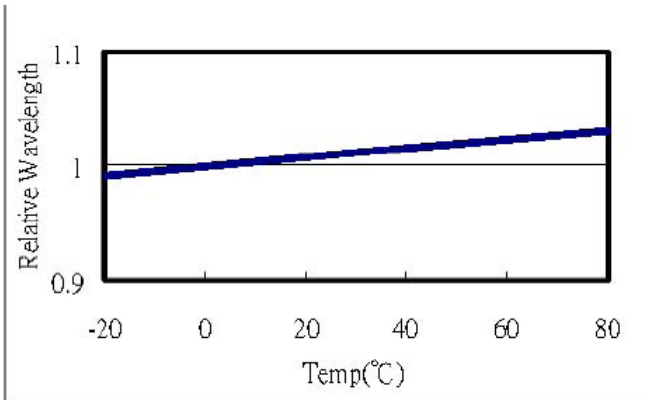
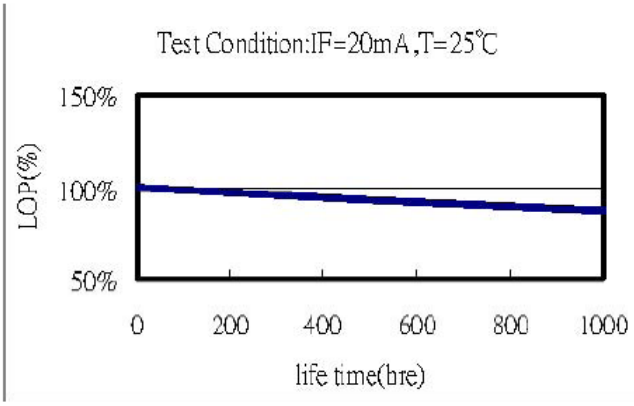


Fig6. Life Test at 20mA R.T. 1000hrs:



LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T_a = UNDER ROOM TEMPERATURE $I_F = I_F$ max
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY T_a =65±5°C RH=90~95%RH TEST TIME=240± 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE T_a =85±5°C(COB: Ta=65±5°C) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	IOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE T_a =-35±5°C TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION 85°C ~ 25°C ~ -35°C ~ 25°C 30min 5min 30min 5min 10 CYCLES(COB: Thot=65°C, Tcold=-25°C
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES 85±5°C ~-35±5°C 10min 10min 10 CYCLES(COB: Thot=65°C,Tcold=-25°C
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE T.SOL=230±5°C DWELL TIME=5±1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING T.SOL=260±5°C DWELL TIME=10±1sec.

Package method 1:

200 pcs / Red Expandable Polyethylene.

1400 pcs / Box(360*175*130mm).

8400 pcs / Carton(550*380*280mm).

Packing method B:

40 pcs / IC Tube.

2160 pcs / Box(537*175*125mm).

8640 pcs / Carton(550*380*280mm).